

CURABLE EPOXY COMPOSITIONS AND ARTICLES
MADE THEREFROM

ABSTRACT OF THE DISCLOSURE

[0034] A curable epoxy formulation comprising at least one epoxy monomer, at least one organofunctionalized colloidal silica, at least one alkyl onium cure catalyst, and optional reagents is provided in the present invention. Also disclosed are a packaged solid state device comprising an encapsulant comprising the aforementioned curable epoxy formulation.